#### SCOPE:

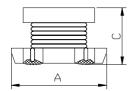
This specification applies to the Pb Free high current type SMD inductors for MSCH-2015C-SERIES

#### PRODUCT INDENTIFICATION

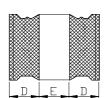
MSCH - 2015C - 100 K

- 1
- 2
- 3 4
- ① Product Code
- ② Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code

# (1) SHAPES AND DIMENSIONS







A: 2.0±0.3	mm
B: 1.5±0.2	mm
C: 1.7±0.3	mm
D: 0.6Typ.	mm
E: 0.8Typ.	mm

# (2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

**TEST INSTRUMENTS** 

L : HP 4285A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

## (3) CHARACTERISTICS

- (3)-1 Ambient temperature ...... +60°C Max.
- (3)-2 Operate temperature range ......  $-40^{\circ}$ C  $\sim$   $+125^{\circ}$ C (Including self temp. rise)
- (3)-3 Storage temperature range ......  $-40^{\circ}$ C  $\sim +125^{\circ}$ C



## **TABLE 1**

MAGLAYERS	Inductance	Percent	L Test	Resistance	IDC
PT/NO.	L(µH)	Tolerance	Frequency	RDC(Ω)Max.	(mA) Max.
MSCH-2015C-1R0□	1.0	М	1MHz/0.25V	0.26	650
MSCH-2015C-1R5□	1.5	М	1MHz/0.25V	0.35	600
MSCH-2015C-2R2□	2.2	М	1MHz/0.25V	0.52	500
MSCH-2015C-3R3□	3.3	М	1MHz/0.25V	0.65	480
MSCH-2015C-4R7□	4.7	М	1MHz/0.25V	0.78	300
MSCH-2015C-5R6□	5.6	М	1MHz/0.25V	0.84	280
MSCH-2015C-6R8□	6.8	М	1MHz/0.25V	1.30	250
MSCH-2015C-8R6□	8.6	М	1MHz/0.25V	1.52	230
MSCH-2015C-100□	10	K,M	1MHz/0.25V	1.62	200
MSCH-2015C-150□	15	K,M	1MHz/0.25V	2.01	150
MSCH-2015C-220□	22	K,M	1MHz/0.25V	3.77	100

 $<sup>\</sup>divideontimes$   $\square$  specify the inductance tolerance,K(±10%),M(±20%)

<sup>%</sup> IDC ∶ Based on inductance change ( $\triangle$ L/Lo ∶  $\leq$  drop 10%) @ ambient temp. 25°C

# (4) RELIABILITY TEST METHOD

## **MECHANICAL**

SPECIFICATION	TEST DETAILS
∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board
	in figure 1 and a load applied unitil the figure in the arrow
There shall be	direction is made approximately 3mm.(keep time 30 seconds)
no mechanical	PCB dimension shall the page 7/9
damage or elec-	F(Pressurization)
trical damege.	$\Box$
	R5 45±2 45±2 10 20 R340
	PRESSURE ROD figure-1
∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board
	and when a vibration having an amplitude of 1.52mm
There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should
no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.
damage.	(A total of 6 hours)
New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated
More than 90%	over the whole of the sample before hard, the sample shall
	then be preheated for about 2 minutes in a temperature of
	130∼150°C and after it has been immersed to a depth 0.5mm
	below for 3±0.2 seconds fully in molten solder M705 with
	a temperature of 245±5℃.
	More than 90% of the electrode sections shall be couered
	with new solder smoothly when the sample is taken out of
	the solder bath.
	△L/Lo≦±5%  There shall be no mechanical damage or electrical damege.  △L/Lo≦±5%  There shall be no mechanical damage.



## **MECHANICAL**

TEST ITEM	SPECIFICATION		
TEST ITEM Resistance to Soldering heat (reflow soldering)	There shall be no damage or problems.	Temperature profile of reflow soldering    Soldering	

#### **ELECTRICAL**

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top
resistance	no other	surface and the terminal.
	damage or	The insulation resistance shall be more than 1 × $10^8$ $\Omega$ .
	problems.	
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^{\circ}\mathrm{C}$ ,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20°C ≦±10%.

# **ENVIROMENT CHARACTERISTICS**

TEST ITEM			SPECIFICATION		
High temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmospere with			
storage					
	There shall be				
	no mechanical				
	damage.				
Low temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmosphere with			
storage		a temperature of -25±3℃.			
	There shall be	Upon comp	Upon completion of the test, the measurement shall be made		
	no mechanical	after the sa	mple has been left in a no	rmal temperature and	
	damage.	normal hun	normal humidity for 1 hour.		
Change of	∆L/Lo≦±5%	The sample shall be subject to 5 continuos cycles, such as shown			
temperature		in the table 2 below and then it shall be subjected to standard			
	There shall be	atmospheric conditions for 1 hour, after which measurement			
	no other dama-	na- shall be made.			
	ge of problems				
			table 2		
			Temperature	Duration	
		1	<b>−25±3°</b> C	30 min.	
			(Themostat No.1)	30 mm.	
		2	Standard	N. 4. N. O	
			atmospheric	No.1→No.2	
		3	<b>85±2</b> ℃	30 min.	
			(Themostat No.2)	50 mm.	
		4	Standard	Na O Na A	
			atmospheric	No.2→No.1	
Moisture storage	∧ I /I o< ±59/	The sample	shall be left for 96±4 hour	es in a temperature of	
moisture storage	∆L/Lo≦±5%	•		·	
	There shall be		a humidity(RH) of $90\sim95^{\circ}$		
	There shall be	Upon completion of the test, the measurement shall be made			
	no mechanical	after the sample has been left in a normal temperature and			
	damage.	normai nun	nidity more than 1 hour.		

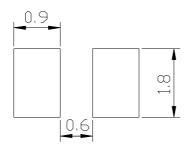


# (5) LAND DIMENSION (Ref.)

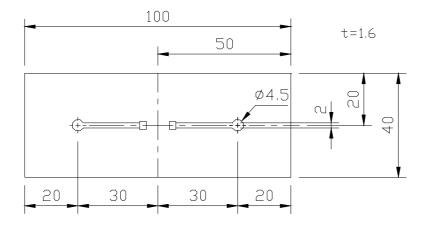
PCB: GLASS EPOXY t=1.6mm

#### (5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) unit: mm



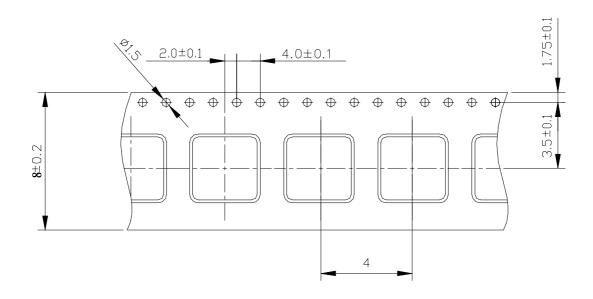
## (5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



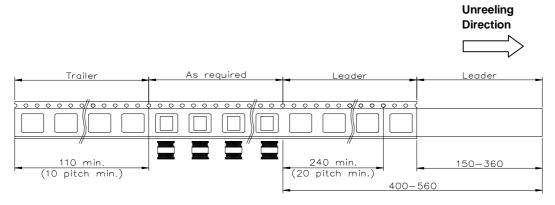


## (6) PACKAGING

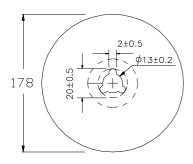
## (6)-1 CARRIER TAPE DIMENSIONS (mm)

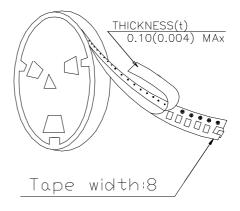


## (6)-2 TAPING DIMENSIONS (mm)



# (6)-3 REEL DIMENSIONS (mm)





## (6)-4 QUANTITY

2500pcs/Reel

The products are packaged so that no damage will be sustained.